

MAIL DATE **SEP 09 2004** **COMBINED DECLARATION / POWER OF ATTORNEY**

ATTORNEY DOCKET NO. 980238

AS BELOW NAMED INVENTOR, I HEREBY DECLARE THAT: This Declaration is of the following type:

- ☒ Original ☐ Supplemental ☐ Continuation-In-Part ☐ Divisional
☐ Continuation ☐ National Stage of PCT

My residence, post office address and citizenship are as stated below next to my name: I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention Systems and Methods for Hierarchically Demodulating and Decoding a Data Signal Using a Pilot Signal and an Additional Signal the specification of which:

- ☐ is attached hereto.
☒ was filed on February 17, 2004 as Serial No. 10/781,461.
☐ was amended on (if applicable).
☐ was described and claimed in PCT International Application No. filed on and as amended under PCT Article 19 on

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above. I acknowledge the duty to disclose information which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations, Sec. 1.56(a).

I hereby claim foreign priority benefits under Title 35, United States Code, Sec. 119 of any foreign application(s) for patent or inventor's certificate or of any PCT International application(s) designating at least one country other than the United States of America listed below and have also identified below any foreign application(s) for patent or inventor's certificate or any PCT International application(s) designating at least one country other than the United States of America filed by me on the same subject matter having a filing date before that of the application(s) of which priority is claimed.

Priority Claimed				
(Country)	(Application No.)	(Day/Month/Year/Filed)	(Yes)	(No)

I hereby claim the benefit under Title 35 USC 119(e) of any United States provisional application(s) listed below:

60/448,269 (Serial No.)	02/18/03 (Filing Date)	PENDING (Status)
60/452,790 (Serial No.)	03/06/03 (Filing Date)	PENDING (Status)
60/470,770 (Serial No.)	05/14/03 (Filing Date)	PENDING (Status)

I hereby claim the benefit under Title 35 USC 120 of the United States application(s) listed below, and insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35 USC 112, I acknowledge the duty to disclose material information as defined in Title 37 CFR 1.56(a) which occurred between the filing date of the prior application and the national or PCT International filing date of this application:

(Serial No.)	(Filing Date)	(Status)
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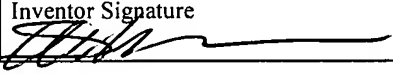
I hereby appoint the attorneys and/or agents associated with Customer No. 23696 to prosecute this application and to transact all business in the U.S. Patent and Trademark Office connected therewith. Please direct all telephone calls to Philip R. Wadsworth at (858) 651-4404 and address all correspondence to: QUALCOMM Incorporated, Patent Department, 5775 Morehouse Drive, San Diego, California 92121-1714.

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Full Name of First or Joint Inventor Yongbin Wei	Inventor Signature 	Date 8/12/04
Residence San Diego, California	Citizenship CN	
Mailing Address 12140 Brickellia Street, San Diego, California, 92129		

Full Name of Second or Joint Inventor Durga P. Malladi	Inventor Signature <i>MDhasad</i>	Date 8/11/04
Residence San Diego, California	Citizenship IN	
Mailing Address 11983 Briarleaf Way, San Diego, California, 92128		
Full Name of Third or Joint Inventor Stein Lundby	Inventor Signature <i>S. Lundby</i>	Date 8/11/04
Residence Solana Beach, California	Citizenship CH	
Mailing Address 716 North Granados Avenue, Solana Beach, California 92075		
Full Name of Fourth or Joint Inventor Tao Chen	Inventor Signature <i>Tao Chen</i>	Date 8.11.04
Residence La Jolla, California	Citizenship US	
Mailing Address 7826 East Roseland Drive, La Jolla, CA 92037		
Full Name of Fifth or Joint Inventor Serge Willenegger	Inventor Signature	Date
Residence 1420 Onnens, Switzerland	Citizenship CH	
Mailing Address Vignes-Dessous, 1425 Onnens, Switzerland		

QUALCOMM, Inc.
 5775 Morehouse Drive
 San Diego, California 92121-1714
 Telephone: (858) 658-5787
 Facsimile: (858) 658-2502

Full Name of Second or Joint Inventor Durga P. Malladi	Inventor Signature	Date
Residence San Diego, California	Citizenship IN	
Mailing Address 11983 Briarleaf Way, San Diego, California, 92128		
Full Name of Third or Joint Inventor Stein Lundby	Inventor Signature	Date
Residence Solana Beach, California	Citizenship CH	
Mailing Address 716 North Granados Avenue, Solana Beach, California 92075		
Full Name of Fourth or Joint Inventor Tao Chen	Inventor Signature	Date
Residence La Jolla, California	Citizenship US	
Mailing Address 7826 East Roseland Drive, La Jolla, CA 92037		
Full Name of Fifth or Joint Inventor Serge Willenegger	Inventor Signature 	Date August 10th 2009
Residence 1420 Onnens, Switzerland	Citizenship CH	
Mailing Address Vignes-Dessous, 1425 Onnens, Switzerland		

QUALCOMM, Inc.
 5775 Morehouse Drive
 San Diego, California 92121-1714
 Telephone: (858) 658-5787
 Facsimile: (858) 658-2502